MOTOROLAD供应商 SEMICONDUCTOR TECHNICAL DATA

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MAC12 SERIES * *Motorola preferred devices

Advance Information

TRIACS Silicon Bidirectional Thyristors

Designed for high performance full–wave ac control applications where high noise immunity and commutating di/dt are required.

- Blocking Voltage to 800 Volts
- On-State Current Rating of 12 Amperes RMS at 70°C
- Uniform Gate Trigger currents in Three Modes
- High Immunity to dv/dt 250 V/μs minimum at 125°C
- High Commutating di/dt 6.5 A/ms minimum at 125°C
- Industry Standard TO-220 AB Package
- High Surge Current Capability 120 Amperes



TRIACS

12 AMPERES RMS 400 thru 800

VOLTS

MAXIMUM RATINGS (TJ = 25°C unless otherwise noted)

Parameter		Symbol	Va	Value	
Peak Repetitive Off-State Voltage (1) MAC1 (T _J = -40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) MAC1 MAC1 MAC1	2D 2M 2N	VDRM	400 600 800		Volts
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, T _C = 70°C)	40	IT(RMS)	12 ⁵⁰		A
Peak Non-repetitive Surge Current (One Full Cycle, 60 Hz, TJ = 125°C)	940	ITSM	100		A
ircuit Fusing Consideration (t = 8.3 ms)		l ² t		41	
Peak Gate Power (Pulse Width ≤ 1.0 μs, T _C = 80°C)		P _{GM}	16		Watts
Average Gate Power (t = 8.3 ms, T _C = 80°C)		P _{G(AV)}	0.35		Watts
Operating Junction Temperature Range		Тј	-40 to +125		°C
Storage Temperature Range		T _{stg}		-40 to +150	
THERMAL CHARACTERISTICS		-	87	190.00	and the second se
Thermal Resistance — Junction to Case — Junction to Ambient	48	R _θ JC R _θ JA	2.2 62.5		°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds		тL	260		°C
ELECTRICAL CHARACTERISTICS (T = 25°C unless otherwise noted					
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			1		
Peak Repetitive Blocking Current T ₁ = 25°C	IDRM	—	-	0.01	mA

voltage ratings of the devices are exceeded.

eferred devices are Motorola recommended choices for future use and best overall value.

MAC12 SERIES

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit				
ON CHARACTERISTICS									
Peak On-State Voltage* ($I_{TM} = \pm 17 \text{ A}$)	V _{TM}	—	—	1.85	Volts				
Continuous Gate Trigger Current ($V_D = 12 V, R_L = 100 \Omega$) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	IGT	5.0 5.0 5.0	13 16 18	35 35 35	mA				
Hold Current (V _D = 12 V, Gate Open, Initiating Current = \pm 150 mA)	Ч	_	20	40	mA				
Latch Current (V _D = 24 V, I _G = 35 mA) MT2(+), G(+); MT2(-), G(-) MT2(+), G(-)	١L	_	20 30	50 80	mA				
Gate Trigger Voltage (V _D = 12 V, R _L = 100 Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	VGT	0.5 0.5 0.5	0.69 0.77 0.72	1.5 1.5 1.5	Volts				
DYNAMIC CHARACTERISTICS					-				
Rate of Change of Commutating Current* ($V_D = 400 \text{ V}$, ITM =4.4A, Commutating dv/dt = 18 V/µs, Gate Open, T _J = 125°C, f = 250 Hz, No Snubber)	(dv/dt)c	6.5	_	—	A/ms				
Critical Rate of Rise of Off–State Voltage (V_D = Rated V_{DRM} , Exponential Waveform, Gate Open, T _J = 125°C)	dv/dt	250	—	—	V/µs				

 $(V_D = Rated V_{DRM}, Exponential Waveform, Gate Open, T_J $$ Indicates Pulse Test: Pulse Width $\le 2.0 ms, Duty Cycle $\le 2\%. $$$